

# Using Chemical Vapor Deposition to Grow Thin Film $\text{UTe}_2$

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# Outline

- ❖ Plans for NIST with Chemical Vapor Deposition (CVD)
- ❖ Introduction to CVD
- ❖ Applications of CVD
- ❖ History of Thin Film Uranium Compound Growth
- ❖ My Contribution to the Project

# What does NIST hope to use CVD for?

The goal is to grow  $\text{UTe}_2$  (Uranium ditelluride) thin film crystals using the CVD technique.

Growing thin film  $\text{UTe}_2$  is special because:

- It is a superconductor at low temperatures
- Could be used for future devices
- No one has done it before!



# What makes $\text{UTe}_2$ Unique?

$\text{UTe}_2$  has spin triplet superconductivity

This could be very useful for future quantum technology!

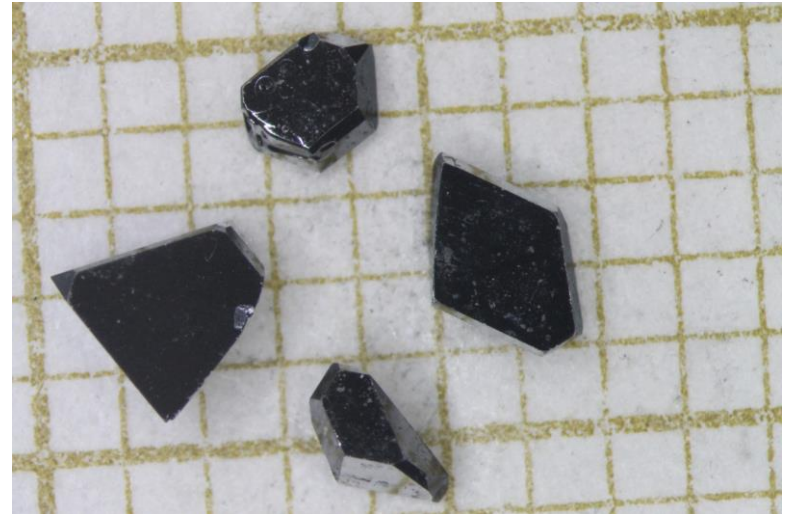


Image from NIST

# What is CVD?

CVD (Chemical Vapor Deposition) is a technique used to grow thin film crystals on a substrate by heating up the reactant gases to create new chemical bonds.

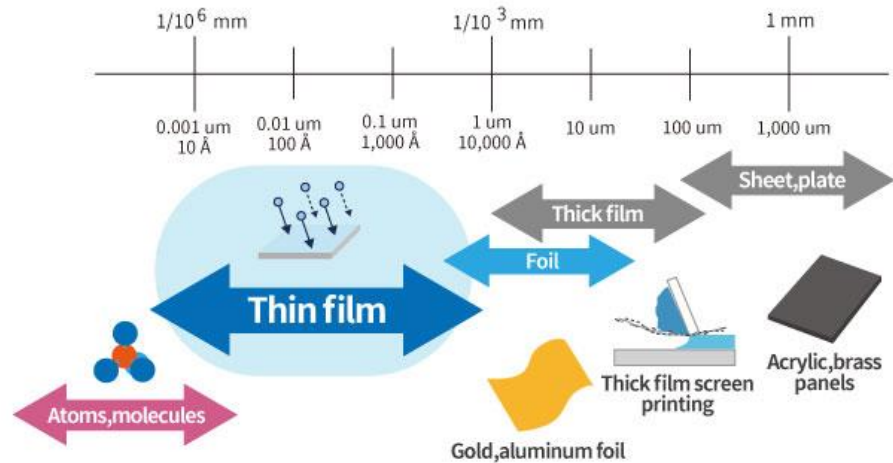


Image from Vac Coat

# How does CVD work?

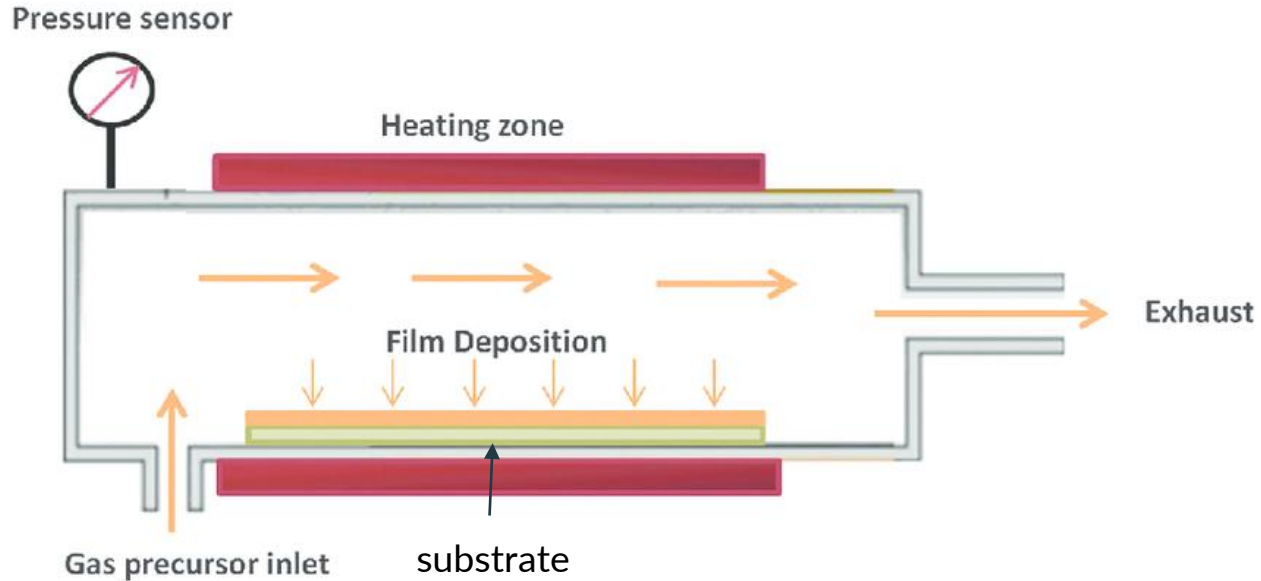


Image from Zhang et. al., 2016

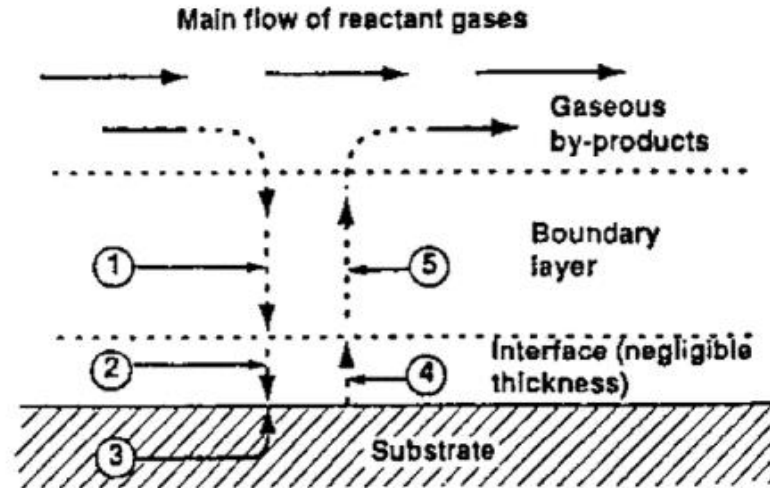
What increases the likelihood of the desired compound growing?

Gibbs Free energy Equation:

$$\Delta G_r = \sum \Delta G_{\text{products}} - \sum \Delta G_{\text{reactants}}$$

# What other scientific considerations need to be considered?

Diagram that demonstrates flow of the gas in the process of CVD



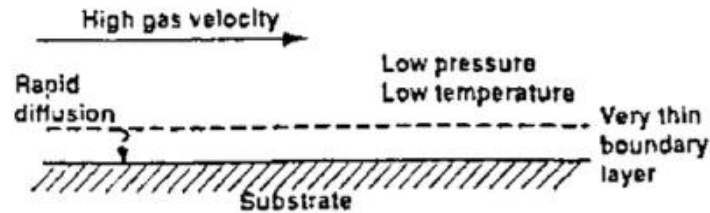
1. Diffusion in of reactants through boundary layer
2. Adsorption of reactants on substrate
3. Chemical reaction takes place
4. Desorption of adsorbed species
5. Diffusion out of by-products

Figure 2.3. Sequence of events during deposition.



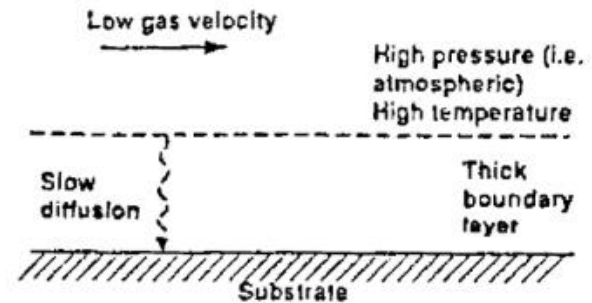
# What controls the growth rate of the crystals?

Low Pressure  
Low Temperature



High Velocity  
Thin boundary layer

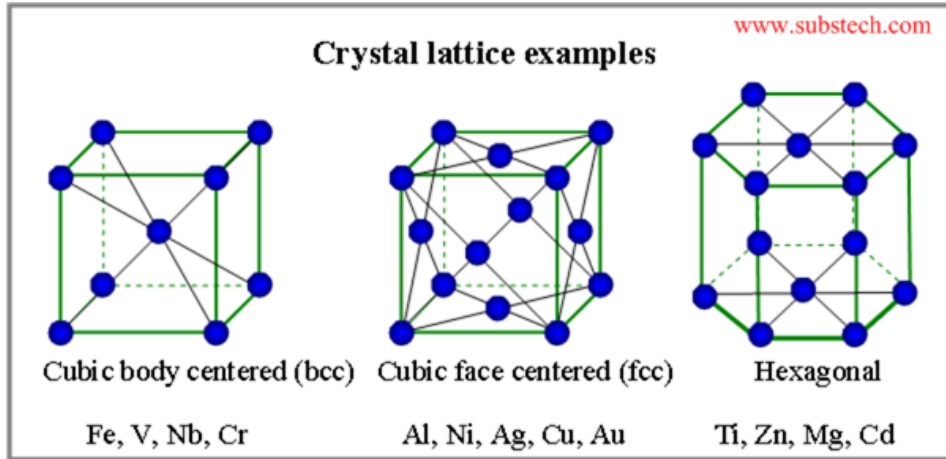
High Pressure  
High Temperature



Low Velocity  
Thicker boundary layer

The goal is to find a balance between these two extremes

# How do you know what substrate to use?



The substrate should match the crystal on lattice structure and parameters

# What are the applications of CVD?

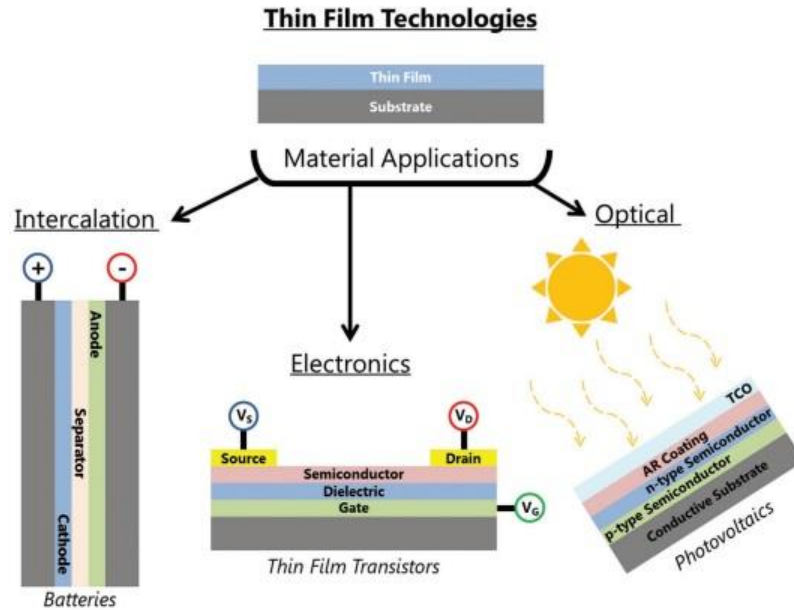


Image from Vac Coat

# History of Thin Film Uranium Compound Growths



- Only dates back to the 1960s
- Not very common for labs to grow thin film uranium compounds
- $\text{UO}_2$  is the most common Uranium compound grown
- Biggest challenges in growing Uranium compounds has been:
  - Lattice matching
  - Surface oxidation

# History of Thin Film Uranium Compound Growths Continued

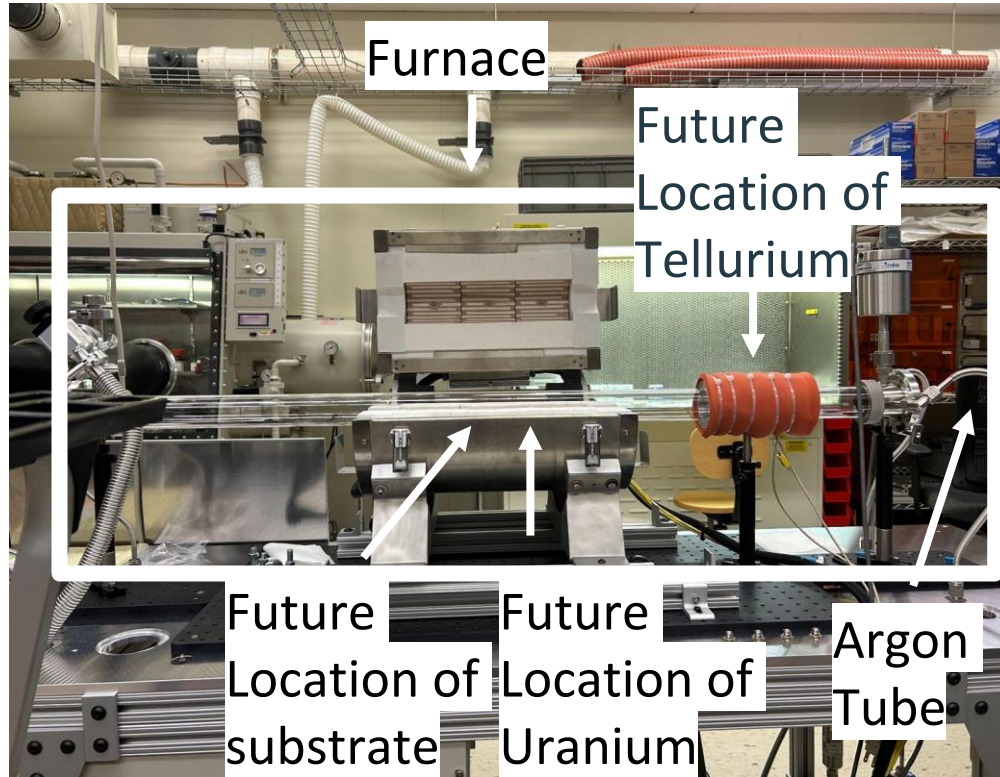


- Scientists have been experimenting over the years with different:
  - Growth techniques (such as CVD and sputtering)
  - Uranium Compound growths (such as  $\text{UO}_2$  and UN)
  - Substrates to deposit on (such as MgO and Sapphire)
  - Starting materials (such as Uranium Oxide and Uranium Iodine)
  - Amounts of starting material

# The Furnace

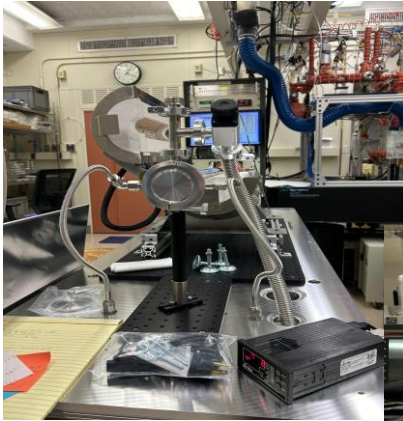


# Description of Furnace





# More Pictures!



View of closed  
Furnace



View of open  
furnace from the  
side



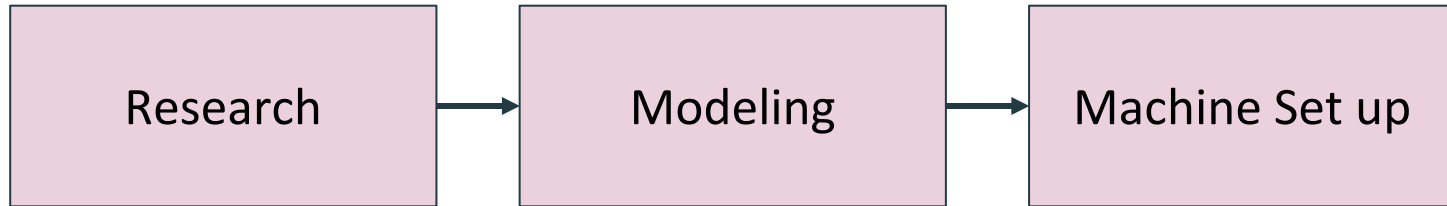
Picture of the  
controls for  
the furnace



Picture of the  
canister to hold  
Uranium exhaust



# My part in the project



# CVD Modeling Equation

$$M = \frac{DA}{LRT} \Delta P$$

M = Mass Transport (kg/s)

D = Diffusion Coefficient = 1.64E-05 cm<sup>2</sup>/s

A = Cross Area of CVD Pipe = 17.35 cm<sup>2</sup>

L = Distance between source and substrate (cm) = Adjusted between .5 and 5 cm

R = Ideal Gas Constant = 82 cm<sup>3</sup> atm/deg

T = Initial Temperature ( C ) = Adjusted between 650 and 850 °C

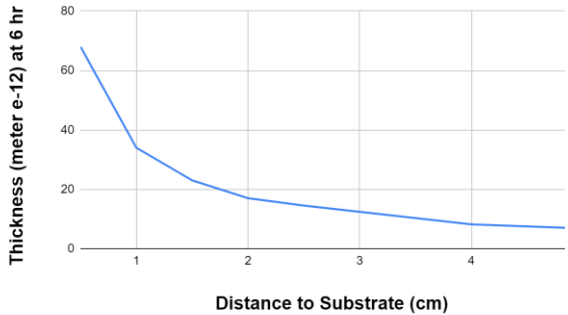
ΔP = change in pressure (atm) = Adjusted between .53 and 1 atm

Experimented with different:

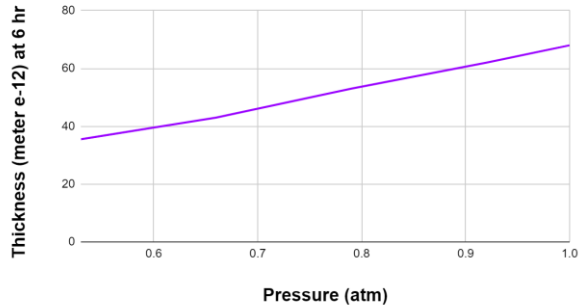
- Distance to Substrate (L)
- Temperature (T)
- Pressure (ΔP)

# CVD Modeling Graphs and Conclusions

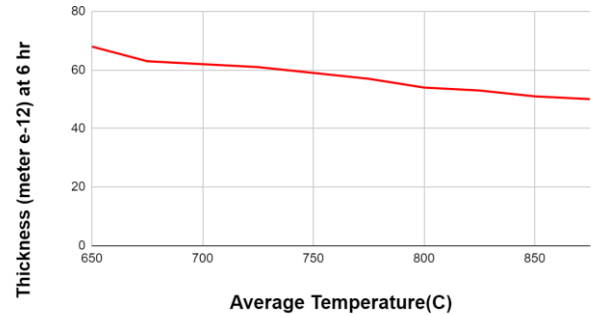
Thickness at 6 hr vs. Distance to Substrate



Thickness at 6 hr vs. Pressure



Thickness at 6 hr vs. Temperature



It is best to have:

- Shortest Distance to Substrate
- Highest Pressure Possible
- Lowest Average Temperature

# Acknowledgements



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Thank you!